

02-13-2009

Attorney Docket No.
75C-001

103548081

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

- (1) Hironobu MATSUZAWA
(2) Tsutomu CHOU
(3) Yoshihiro TSUCHIYA
(4) Shinji HARA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) (1) - (4): December 18, 2008

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

2. Name and address of receiving party(ies)

Name: TDK CORPORATION

Street Address: 1-13-1, Nihonbashi, Chuo-ku

City: Tokyo

State: _____

Country: JAPAN Zip: 103-8272

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No.(s)

12/292,566



This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: DAVID G. POSZ

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6. Total number of applications and patents involved: _____

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40

- ☐ Authorized to be charged by credit card
☒ Authorized any additional fee to be charged/credited to deposit account
☒ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 50-1147

Authorized User Name: DAVID G. POSZ

9. Signature: _____

Signature

February 10, 2009

Date

DAVID G. POSZ (REG. NO. 37,701)

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby expressly acknowledged, the undersigned hereby agree(s) to assign, and hereby, assign(s), sell(s) and transfer(s) to

TDK Corporation

1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272 JAPAN

as Assignee, and its successors, assigns or other legal representatives, the entire right, title and interest, in the United States of America, and its territories, dependencies and possessions, to certain inventions known as

FABRICATION PROCESS FOR MAGNETORESISTIVE DEVICES OF THE CPP TYPE

described in an application for Letters Patent of the United States executed

on even date herewith

X

as U.S. Application Serial No. _____

filed on _____

November 20, 2008

as well as any and all continuations, divisions, and reissues of said application and all Letters Patents that may be granted therefor. The undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent or Letters Patents to said Assignee.

The undersigned agree(s), when requested, to sign all papers, take all rightful oaths, and perform all acts which may be necessary for securing, maintaining and enforcing patents for said inventions and for vesting title thereto in said Assignee.

The undersigned authorize(s) and empower(s) said Assignee to invoke and claim the benefit of the right of priority provided under any and all international conventions and treaties in respect of said inventions, as may be necessary in connection with said application.

The undersigned also authorize(s) Posz Law Group, PLC to insert hereon any further identification that may be necessary or desirable for recordation of this document.

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Inventor 1: Hironobu MATSUZAWA

Dec. 18, 2008
Date

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